

GJ01L60**N-CHANNEL ENHANCEMENT MODE POWER MOSFET**

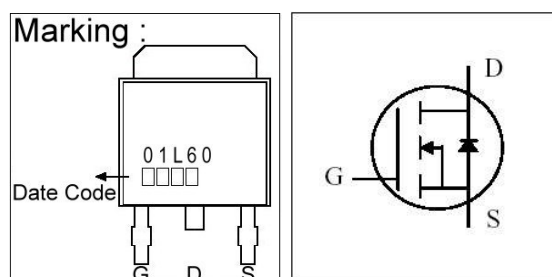
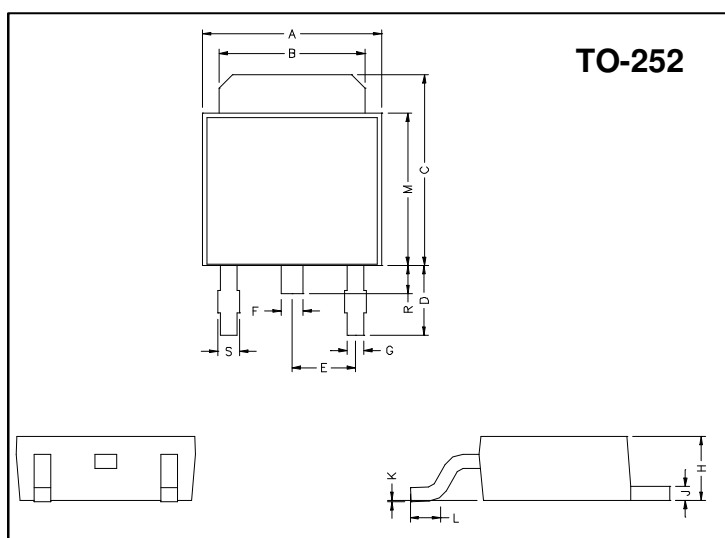
BVDSS	600V
RDS(ON)	12Ω
ID	1A

Description

The GJ01L60 (TO-252) is universally preferred for all commercial-industrial surface mount applications and suited for AC/DC converters.

Features

- *Repetitive Avalanche Rated
- *Simple Drive Requirement
- *Fast Switching Speed
- *RoHS Compliant

Package Dimensions

REF.	Millimeter		REF.	Millimeter	
	Min.	Max.		Min.	Max.
A	6.40	6.80	G	0.50	0.70
B	5.20	5.50	H	2.20	2.40
C	6.80	7.20	J	0.45	0.55
D	2.40	3.00	K	0	0.15
E	2.30 REF.		L	0.90	1.50
F	0.70	0.90	M	5.40	5.80
S	0.60	0.90	R	0.80	1.20

Absolute Maximum Ratings

Parameter	Symbol	Ratings	Unit
Drain-Source Voltage	V_{DS}	600	V
Gate-Source Voltage	V_{GS}	±30	V
Continuous Drain Current, $V_{GS}@10V$	$I_D @T_C=25^{\circ}C$	1	A
Continuous Drain Current, $V_{GS}@10V$	$I_D @T_C=100^{\circ}C$	0.8	A
Pulsed Drain Current ¹	I_{DM}	3	A
Total Power Dissipation	$P_D @T_C=25^{\circ}C$	29	W
Linear Derating Factor		0.232	W/°C
Single Pulse Avalanche Energy ²	E_{AS}	0.5	mJ
Avalanche Current	I_{AR}	1	A
Repetitive Avalanche Energy	E_{AR}	0.5	mJ
Operating Junction and Storage Temperature Range	T_j, T_{stg}	-55 ~ +150	°C

Thermal Data

Parameter	Symbol	Value	Unit
Thermal Resistance Junction-case Max.	$R_{thj-case}$	4.3	°C/W
Thermal Resistance Junction-ambient Max.	$R_{thj-amb}$	110	°C/W

Electrical Characteristics (T_j = 25°C unless otherwise specified)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Drain-Source Breakdown Voltage	BV _{DSS}	600	-	-	V	V _{GS} =0, I _D =1mA
Breakdown Voltage Temperature Coefficient	$\Delta BV_{DSS} / \Delta T_j$	-	0.8	-	V/°C	Reference to 25°C, I _D =1mA
Gate Threshold Voltage	V _{GS(th)}	2.0	-	4.0	V	V _{DS} =V _{GS} , I _D =250uA
Forward Transconductance	g _{fs}	-	0.8	-	S	V _{DS} =10V, I _D =0.5A
Gate-Source Leakage Current	I _{GSS}	-	-	±100	nA	V _{GS} = ±30V
Drain-Source Leakage Current(T _j =25°C)	I _{DSS}	-	-	10	uA	V _{DS} =600V, V _{GS} =0
Drain-Source Leakage Current(T _j =150°C)		-	-	100	uA	V _{DS} =480V, V _{GS} =0
Static Drain-Source On-Resistance ³	R _{DS(ON)}	-	-	12	Ω	V _{GS} =10V, I _D =0.5A
Total Gate Charge ³	Q _g	-	4.0	-	nC	I _D =1A V _{DS} =480V V _{GS} =10V
Gate-Source Charge	Q _{gs}	-	1.0	-		
Gate-Drain ("Miller") Change	Q _{gd}	-	1.1	-		
Turn-on Delay Time ²	T _{d(on)}	-	6.6	-	ns	V _{DD} =300V I _D =1A V _{GS} =10V R _G =3.3Ω R _D =300Ω
Rise Time	T _r	-	5.0	-		
Turn-off Delay Time	T _{d(off)}	-	11.7	-		
Fall Time	T _f	-	9.2	-		
Input Capacitance	C _{iss}	-	170	-	pF	V _{GS} =0V V _{DS} =25V f=1.0MHz
Output Capacitance	C _{oss}	-	30.7	-		
Reverse Transfer Capacitance	C _{rss}	-	5.1	-		

Source-Drain Diode

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Forward On Voltage ³	V _{SD}	-	-	1.2	V	I _S =1A, V _{GS} =0V, T _j =25°C
Continuous Source Current (Body Diode)	I _S	-	-	1	A	V _D =V _G =0V, V _S =1.2V
Pulsed Source Current (Body Diode) ¹	I _{SM}	-	-	5	A	

Notes: 1. Pulse width limited by safe operating area.

2. Staring T_j=25°C, V_{DD}=50V, L=1.0mH, R_G=25Ω, I_{AS}=1.0A.

3. Pulse width ≤ 300us, duty cycle ≤ 2%.

Characteristics Curve

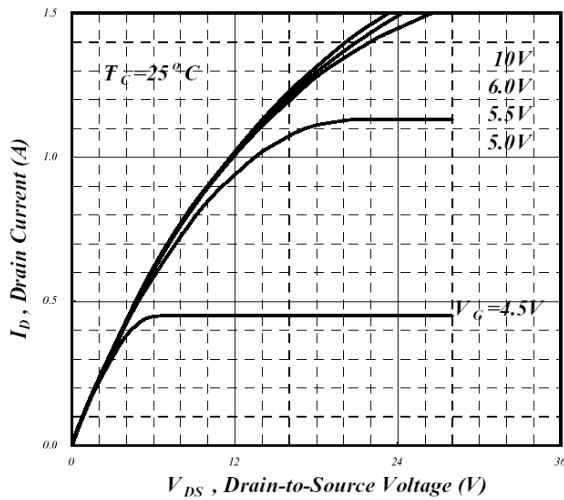


Fig 1. Typical Output Characteristics

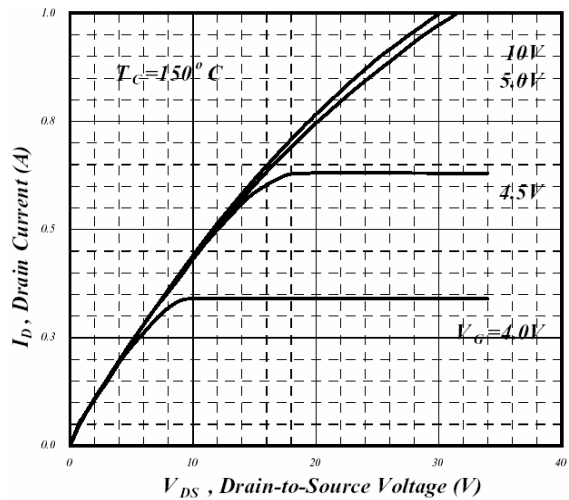


Fig 2. Typical Output Characteristics

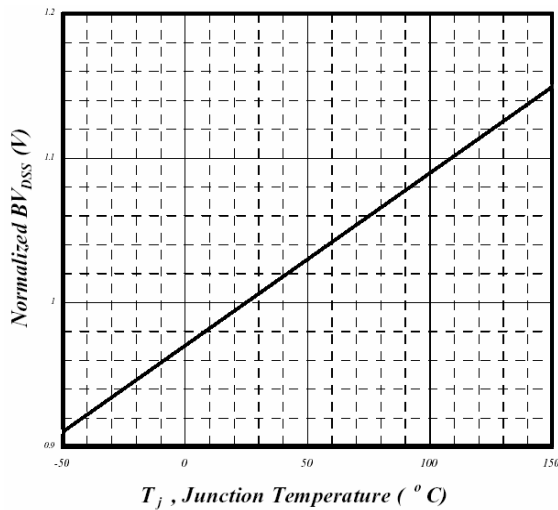


Fig 3. Normalized BV_{DSS} v.s. Junction Temperature

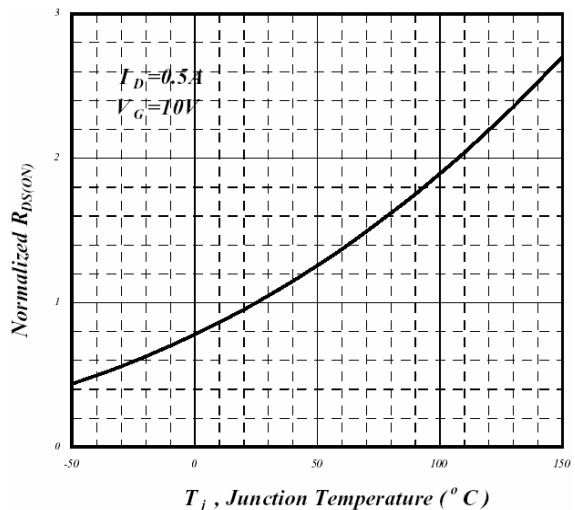


Fig 4. Normalized On-Resistance v.s. Junction Temperature

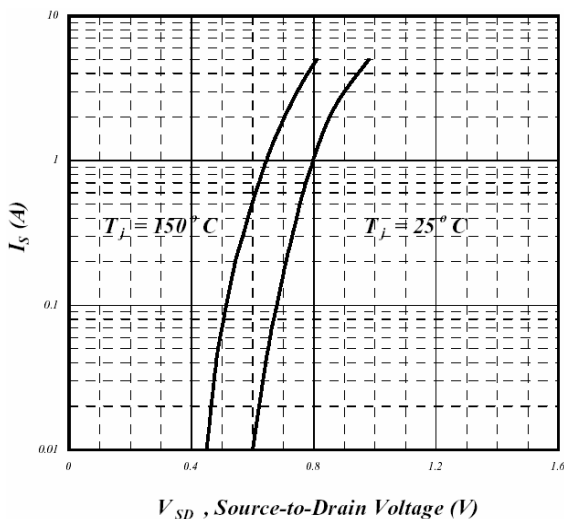


Fig 5. Forward Characteristics of Reverse Diode

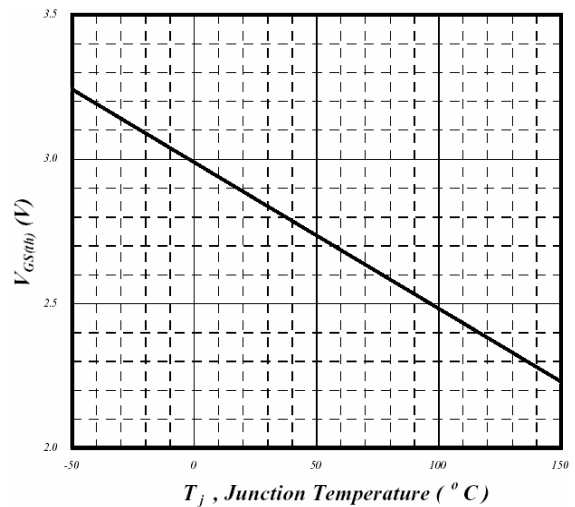


Fig 6. Gate Threshold Voltage v.s. Junction Temperature

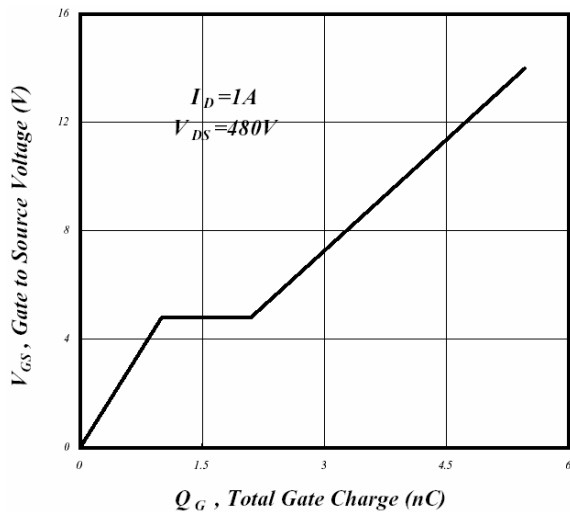


Fig 7. Gate Charge Characteristics

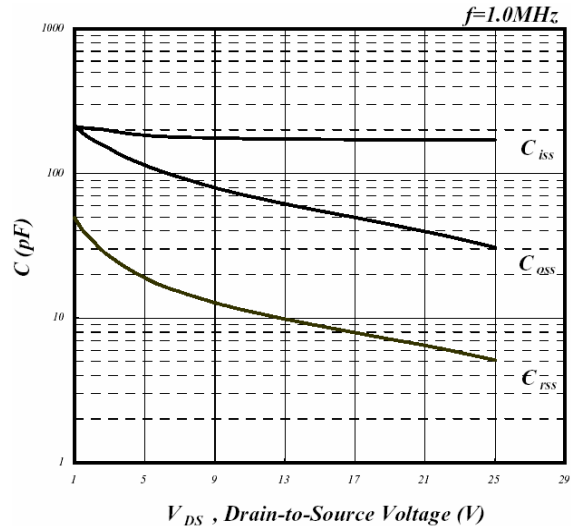


Fig 8. Typical Capacitance Characteristics

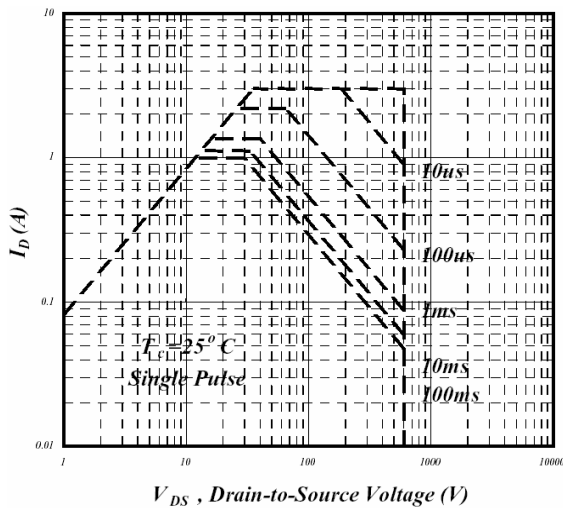


Fig 9. Maximum Safe Operating Area

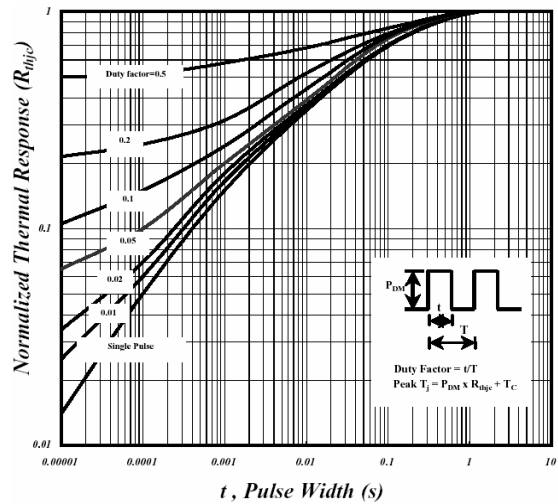


Fig 10. Effective Transient Thermal Impedance

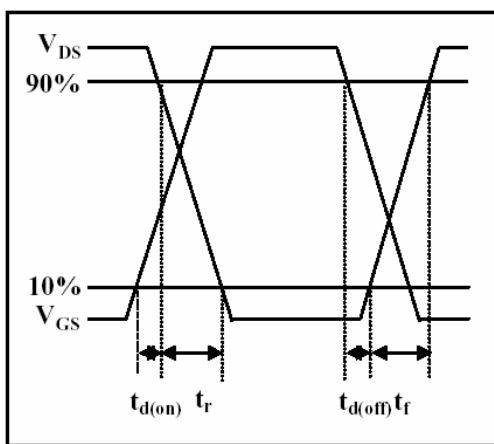


Fig 11. Switching Time Waveform

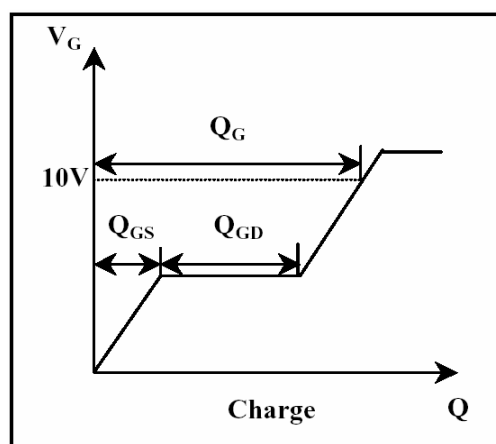


Fig 12. Gate Charge Waveform

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